

PCL-FR-226/PCL-FRP-226 (also PCL-FR-240 and GE 313)

Tetrafunctional FR-4 Laminates and Prepregs
(T_g 140°C)

GENERAL INFORMATION

PCL-FR-226 laminates and PCL-FRP-226 prepregs are the industry benchmark 140°C glass transition temperature (T_g) FR-4 system for multilayer printed wiring boards (PWB). 226 laminate and prepreg products are manufactured using a precise blend of tetrafunctional and difunctional epoxy resins, reinforced with electrical grade (E-glass) glass fabric. This combination provides an exceptional PWB performance and excellent FR-4 processability due to the superior thermal, mechanical, chemical and moisture resistance properties. The 226 system is also laser fluorescing and UV blocking for maximum compatibility with automated optical inspection systems (AOI), optical positioning systems and photoimageable soldermask imaging.

LAMINATE AVAILABILITY

PCL-FR-226 laminates are available in standard thicknesses, using a variety of glass style constructions, from .002 inches (.05 mm) to .125 inches (3.2 mm). Single ply laminates are available in thicknesses from .002 inches (.05 mm) to .010 inches (.25 mm) and multiple ply laminates are available from .004 inches (.10 mm) to .125 inches (3.2 mm). Standard copper claddings are available from 3/8 ounce (12 micron) to 3 ounce (103 microns). Polyclad's patented DSTFoil[®] copper foil cladding is standard but traditional copper foil and double treat clad products are available. Other thicknesses and copper claddings can be custom made to meet specific performance requirements.

PREPREG AVAILABILITY

PCL-FRP-226 prepregs are available in E-glass styles 106, 1080, 2313, 3313, 2116, 2165, 2157 and 7628. Other glass styles may be available to meet specific needs. When fully cured 226 prepreg has the same performance attributes as 226 laminate. Standard flow and fill performance parameters designed to meet typical process and application requirements are available in all the above glass styles. Special performance and no/low flow variations can be custom made for some glass styles for specific applications.

PROCESSING AND STORAGE

226 laminates and prepregs are compatible with and perform excellently using standard FR-4 process techniques. General process recommendation technical bulletins are available from Polyclad. For specific processing guidelines please contact Polyclad Technical Services.

Storage of 226 laminates and prepregs is the same as for all FR-4 materials. Prepregs should be stored at 70±4° F (21±2°C) and 30-50% relative humidity. Prepregs stored below recommended temperatures should be allowed to equilibrate to the above specified conditions for eight hours prior to use. More detailed storage recommendation technical bulletins are available from Polyclad.

APPLICABLE SPECIFICATIONS AND RECOGNITIONS

Polyclad's UL file number is E45456. PCL-FR-226 laminate is UL listed under the generic designation PCL-FR- (a)(a) and PCL-FRP-226 prepreg is listed under the generic designation PCL-FRP- (a)(a). 226 laminates and prepregs and PWBs constructed from them are all capable of achieving a UL 94-V0 flammability rating and the highest UL maximum continuous operating temperature for FR-4 grades of 130°C, and are interchangeable from a UL listing standpoint with all Polyclad FR-4 grades. Certain other more specific parts of Polyclad's UL listing may be applicable in some cases. 226 Laminates and prepregs can be certified to IPC-4101, Specification for Base Materials for Rigid and Multilayer Printed Boards, Specification Sheet IPC-4101/21. Other industry or customer specific specifications, recognitions or designations may be applicable or certifiable to in certain cases. If you need additional information or have questions, please contact Polyclad Technical Services.

POLYCLAD LAMINATE/PREPREG GRADE - PCL-FR-226/PCL-FRP-226

IPC-4101 SPECIFICATION SHEET DESIGNATION(S) /21

LAMINATE

Property		Typical Values/IPC-4101/21 Specification				Units	Test Method
		<.031 in (thickness <.78mm)		≥.031 in (thickness > .78mm)			
		Typical Value	IPC-4101 /21 Spec	Typical Value	IPC-4101 /21 Spec		
Tg by DSC		140	110 min	140	110 min	(°C)	2.4.25
Decomposition Temperature		320	—	320	—	(°C)	ASTMD3850
Z CTE	A. Pre-Tg	—	—	50	—	(PPM/°C)	2.4.24
	B. Post-Tg	—	—	250	—		
X, Y, CTE	A. Pre-Tg	—	—	15	—	(PPM/°C)	2.4.24
	B. Post-Tg	—	—	17	—		
Thermal Conductivity		—	—	0.36	—	W/MK	ASTMD5930
Thermal Stress 20 Sec @288°C, spec minimum	A. Unetched	Pass	Pass Visual	Pass	Pass Visual	Pass/Fail	2.4.13.1
	B. Etched	Pass	Pass Visual	Pass	Pass Visual		
Permittivity, spec maximum	A. @ 1MHz	4.6	5.4	4.8	5.4	—	2.5.5.9
	B. @100MHz	4.5	—	4.6	—		
	C. @1GHz	4.3	—	4.5	—		
Loss Tangent, spec maximum	A. @ 1MHz	0.015	0.035	0.015	0.035	—	2.5.5.9
	B. @100MHz	0.015	—	0.015	—		
	C. @1GHz	0.015	—	0.015	—		
Volume Resistivity, spec minimum	A. C-96/35/90	4.0x10 ⁶	10 ⁶	—	—	(MEGOHM-CM)	2.5.17.1
	B. After moisture resistance	—	—	4.0x10 ⁸	10 ⁶		
	C. At elevated temperature	7.0x10 ⁷	10 ³	7.0x10 ⁷	10 ³		
Surface Resistivity, spec minimum	A. C-96/35/90	3.0x10 ⁶	10 ⁴	—	10 ⁴	(MEGOHM)	2.5.17.1
	B. After moisture resistance	—	—	3.0x10 ⁶	10 ³		
	C. At elevated temperature	6.0x10 ⁶	10 ³	6.0x10 ⁶	—		
Dielectric Breakdown, spec minimum		—	—	60	40	(KV)	2.5.6
Arc Resistance, spec minimum		105	60	105	60	Sec.	2.5.1
Electric Strength, spec minimum (Laminate or prepreg as laminated)		1200 (4.7x10 ⁴)	750 (3.0x10 ⁴)	—	—	VOLT/MIL (VOLT/MM)	2.5.6.2
CTI		—	—	205 (CL=3)	175-250	VOLTS	UL-746A ASTMD3638
Peel Strength, spec minimum	A. Low profile copper foil and very low profile – all copper weights >17 microns	6.0(105)	4.0(70)	6.0(105)	4.0(70)	Lbs/inch (Kg/M)	2.4.8
	B. Standard profile copper foil	—	—	—	—		
	1. After thermal stress	8.0(145)	4.5(80)	8.0(145)	6.0(105)		
	2. At 125°C	7.0(125)	4.0(70)	7.0(125)	4.0(70)		
3. After process solutions	8.0(145)	3.0(55)	8.0(145)	4.5(80)			
Flexural Strength, spec minimum	A. Length direction	—	—	6.4X10 ⁴ (4.5X10 ⁷)	6.0X10 ⁴ (4.2X10 ⁷)	PSI (Kg/M ²)	2.4.4
	B. Cross direction	—	—	6.3X10 ⁴ (4.4X10 ⁷)	5.0X10 ⁴ (3.5X10 ⁷)		
Young's Modulus by DMA		18.0	—	23.0	—	(GPA)	2.4.24.4
Poisons Ratio (X,Y)		—	—	0.18/0.20	—	—	ASTM
Moisture Absorption, spec maximum		0.30	0.80	0.20	0.35	%	2.6.2.1
Flammability		V0	V0	V0	V0	—	UL-94

PREPREG

Property	Typical Value	IPC-4101 Specification	Unit	Test Method
Volatile Content Spec maximum	0.25	0.75	%	2.3.19
Shelf life at 50% RH Maximum, 70°F (20°C) Maximum	Meets requirement	90 days (from date of delivery)	Days	—

Information contained in this data sheet represents typical or average values and does not constitute any warranty or guarantee.